

FQD20N06L / FQU20N06L N-Channel QFET® MOSFET

60 V, 17.2 A, 42 mΩ

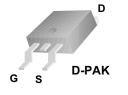


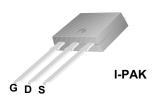
Description

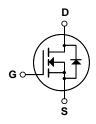
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 17.2 A, 60 V, $R_{DS(on)}$ =42 $m\Omega(Max.)@V_{GS}$ =10 V, I_D =8.6A
- Low Gate Charge (Typ. 9.5 nC)
- Low C_{rss} (Typ. 35 pF)
- · 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating







Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD20N06L / FQU20N06L	Unit
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°C)		17.2	А
	- Continuous (T _C = 100°C)		10.9	А
I _{DM}	Drain Current - Pulsed	(Note 1)	68.8	Α
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	170	mJ
I _{AR}	Avalanche Current	(Note 1)	17.2	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *		2.5	W
	Power Dissipation (T _C = 25°C)		38	W
	- Derate above 25°C		0.30	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.28	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 48 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics				1	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 8.6 A		0.046	0.06	-
'VDS(on)	On-Resistance	V _{GS} =5V,I _D =8.6A		0.057	0.075	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 25 V, I _D = 8.6 A (Note 4)		11		S
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		480 175	630 230	pF pF
C _{rss}	Reverse Transfer Capacitance			35	45	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 10.5 A,		10	30	ns
t _r	Turn-On Rise Time	$V_{DD} = 30 \text{ V}, V_{D} = 10.3 \text{ A},$ $R_{G} = 25 \Omega$		165	340	ns
t _{d(off)}	Turn-Off Delay Time	1 NG - 23 32		35	80	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		70	150	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 21 A,		9.5	13	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		2.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		5.5		nC
						1
	Source Diode Characteristics a				47.0	
I _S	Maximum Continuous Drain-Source Diode Forward Current				17.2	A
I _{SM}	Maximum Pulsed Drain-Source Diode F				68.8	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V, } I_{S} = 17.2 \text{ A}$			1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_F = 21 \text{ A,}$		54		ns
Q_{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$ (Note 4)		75		nC

- Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature 2. L = $670\mu H$, $I_{AS} = 17.2A$, $V_{DD} = 25V$, $R_{G} = 25~\Omega$, Starting $T_{J} = 25^{\circ}C$ 3. $I_{SD} \le 21A$, $di/dt \le 300A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_{J} = 25^{\circ}C$ 4. Pulse Test: Pulse width $\le 300\mu s$, Duty cycle $\le 2\%$ 5. Essentially independent of operating temperature

Typical Characteristics

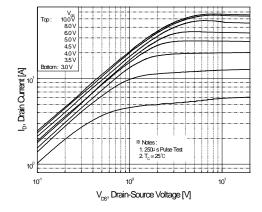


Figure 1. On-Region Characteristics

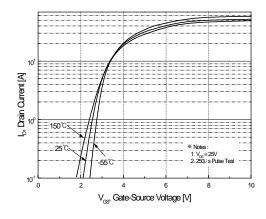


Figure 2. Transfer Characteristics

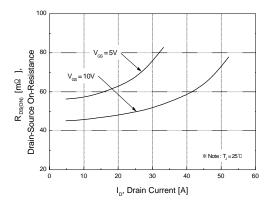


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

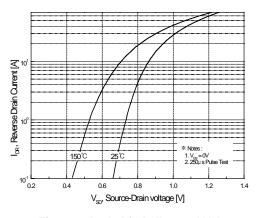


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

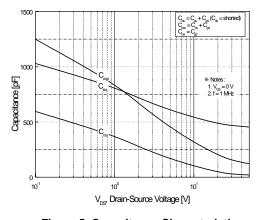


Figure 5. Capacitance Characteristics

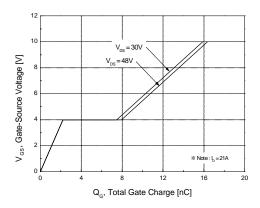
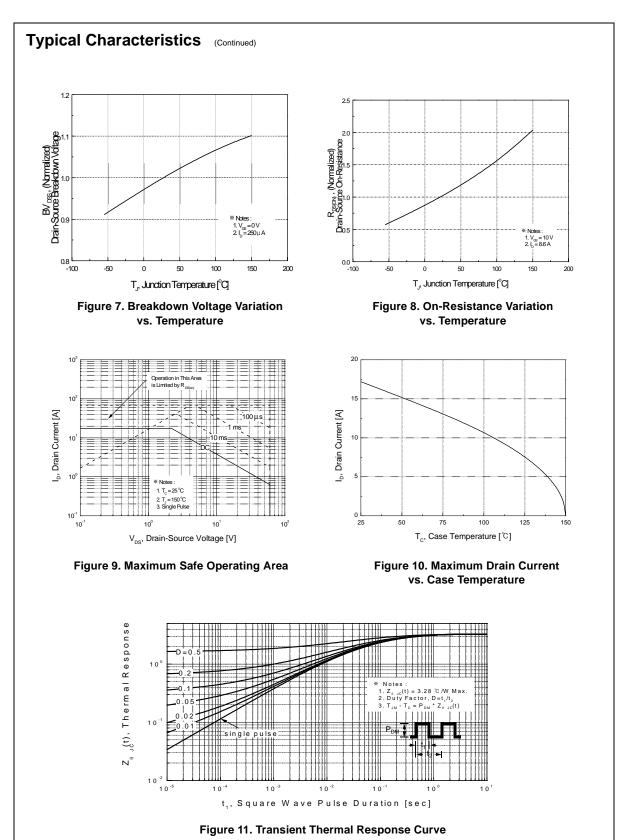
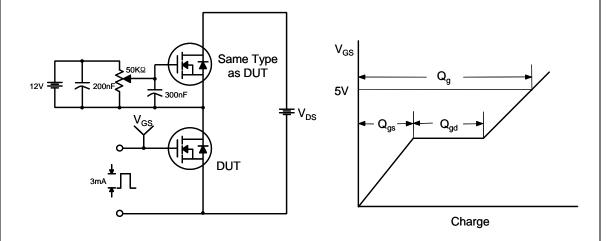


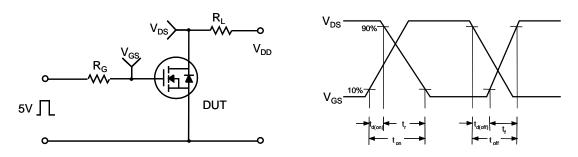
Figure 6. Gate Charge Characteristics



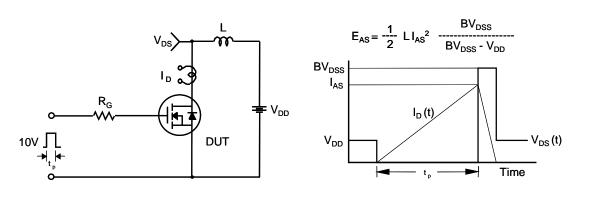
Gate Charge Test Circuit & Waveform



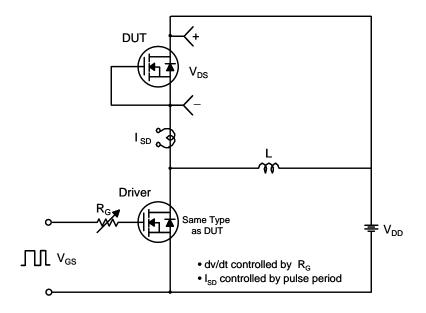
Resistive Switching Test Circuit & Waveforms

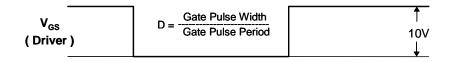


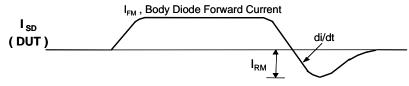
Unclamped Inductive Switching Test Circuit & Waveforms



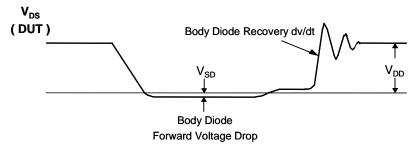
Peak Diode Recovery dv/dt Test Circuit & Waveforms

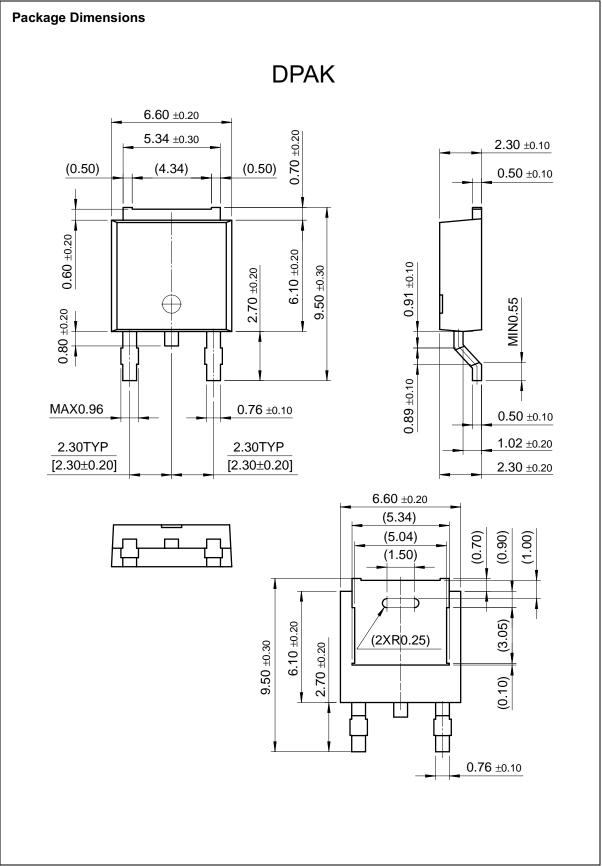


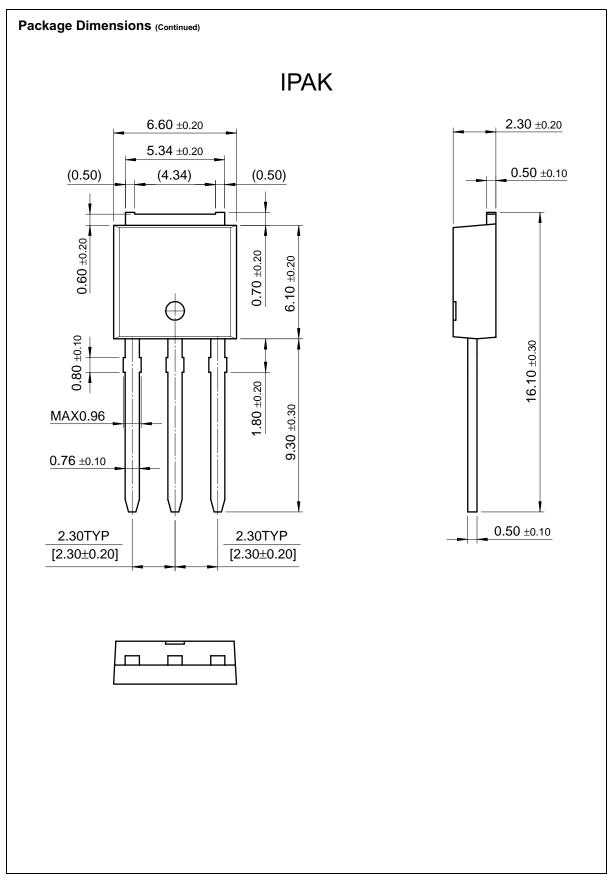




Body Diode Reverse Current











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